MT29FxG08/16

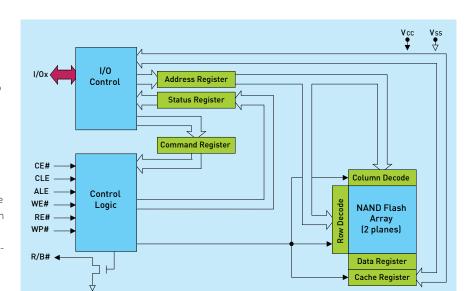
NAND Flash

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To minimize the impact of competing and sometimes incompatible NAND Flash architectures, Micron and several other NAND Flash suppliers, controller manufacturers and designers have joined together to announce the Open NAND Flash Interface (ONFI) standard. The primary goal of the ONFI standard is to increase compatibility and make the embedded system designers' job easier.

The ONFI standard should help minimize the differences among NAND Flash devices from different vendors. However, hardware development to support even these ONFI-compatible devices will still reside with processor manufacturers. The software development required to support all direct-access NAND Flash devices will keep third-party software vendors, developers, and system integration groups busy.

- Open, raw NAND Flash Interface
- Includes NAND vendors, enablers, and customers
- Standardizes the NAND Flash interface
 - Packages
 - Timing parameters
 - Addressing
 - Command set
 - Device behavior
 - Factory marking of bad blocks
- NAND self describes their memory organization, capabilities and supported features to controllers by means of a parameter page
- Reduces time to qualify NAND devices at enablers and OEMs



 ONFI v1.0 spec complete and available for download at www.onfi.org

Micron's high-density, discrete NAND Flash memory devices include 1Gb to 16Gb SLC and 8Gb to 64Gb MLC. All NAND Flash devices (except 1Gb) are moving from 72nm process technology to 50nm now. All 50nm Flash memory devices are designed according to the 0NFI v1.0 standard.

Key Features

- Industry-standard, lead-free TSOP, VFBGA, and LGA packaging
- Bus: x8 and x16 configurations
- Commercial (0...+70°C) and extended (-40...+85°C) operating temperatures

Package

48-pin TSOP

• 3.3V and 1.8V V_{cc} operations

MT29F2G08AADWP-ET:D

• 100,000 PROGRAM/ERASE cycles on SLC

Vicron

- 10,000 PROGRAM/ERASE cycles on MLC
- 2K page size and 128KB block size with performance - enhancing 4K page size available in 2008 starting from 16Gb density

Key Applications

- Industrial applications (e.g. OS Image Storage)
- USB Flash drives
- Cellular phones
- Digital media players
- Digital cameras
- Solid-state drives
- Navigation/GPS systems
- Portable navigation devices (PNDs)

Taping & Reeling

Marking

MIZ7FZGT0AADWF-ET:D	40-piii 130F		
MT29F2G08ABDWP-ET:D	48-pin TSOP		
MT29F2G16ABDWP-ET:D	48-pin TSOP		
MT29F4G08AACWC-ET:C	48-pin TSOP		
MT29F4G16AACWC-ET:C	48-pin TSOP		
MT29F4G08ABCWC-ET:C	48-pin TSOP		
MT29F4G16ABCWC-ET:C	48-pin TSOP		
MT29F8G08AAAWP-ET:A	48-pin TSOP		

